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**ORDINATION FORM COVER SHEET  
PATENTS ONLY**

U.S. DEPARTMENT OF COMMERCE  
Patent and Trademark Office

To the Assistant Commissioner for Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

**Tai Quan,  
Brian L. Smith and  
James C. Lewis**

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

**Sun Microsystems, Inc.  
901 San Antonio Road  
Palo Alto, CA 94303**

Additional name(s) & address(es) attached?

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other

Execution Date: \_\_\_\_\_

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s):

**09815443**

B. Patent No.(s):

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

**Hoyt A. Fleming III  
Park, Vaughan & Fleming LLP  
P.O. Box 3045  
Boise, ID 83703**

Attorney Docket No.: SUN-P6151-RJL

6. Total number of applications and patents involved:  
[1]

7. Total fee (37 CFR 3.41) \$40.00  
☒ Credit Card Payment Form PTO-2038 enclosed  
☐ Authorized to be charged to deposit account

8. Deposit account number: \_\_\_\_\_

**DO NOT USE THIS SPACE**

9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*

Hoyt A. Fleming III  
Name of Person Signing

Hoyt A. Fleming III  
Signature

3-19-01  
Date

Total number of pages including cover sheet, attachments and document: [3]

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**PATENT  
REEL: 011632 FRAME: 0784**

Attorney Docket No.: SUN-P6151-RJL

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**CORPORATE ASSIGNMENT**

WHEREAS, the undersigned,

Tai Quan, having an address of  
3185 Meadowlands Lane, San Jose, CA 95135

Brian L. Smith, having an address of  
1152B La Rochelle Terrace, Sunnyvale, CA 94089 and

James C. Lewis, having an address of  
4499 Venice Way, San Jose, CA 95129

hereinafter termed "Inventor(s)", have invented certain new and useful improvements in

**METHOD AND APPARATUS FOR VERIFYING CONSISTENCY BETWEEN A FIRST ADDRESS REPEATER  
AND A SECOND ADDRESS REPEATER**and have executed a declaration or oath for an application for a United States patent disclosing and  
identifying the invention:☒ On the 19<sup>th</sup> day of March, 2001;

Or

☐ Said application having Application Number \_\_\_\_\_ and filed on \_\_\_\_\_; and

WHEREAS, Sun Microsystems, Inc., a corporation of the State of Delaware, having a place of  
business at 901 San Antonio Road, Palo Alto, CA 94303, (hereinafter termed "Assignee"), is desirous  
of acquiring the entire right, title and interest in and to said application and the invention disclosed  
therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered jointly  
or severally by said Inventor(s) (all collectively hereinafter termed "said invention"), and in and to any  
and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents")  
thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said  
Inventor(s) to have been received in full from said Assignee:

1. Said Inventor(s) do hereby sell, assign, transfer and convey unto said Assignee the entire  
right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply  
for foreign patents on said invention pursuant to the International Convention for the Protection of  
Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents  
granted on said invention in the United States or any foreign country, including each and every  
application filed and each and every patent granted on any application which is a divisional, substitution,  
continuation, or continuation-in-part of any of said applications; and (d) in and to each and every reissue  
or extensions of any of said patents.

2. Said Inventor(s) hereby jointly and severally covenant and agree to cooperate with said  
Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein

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conveyed in the United States and foreign countries. Such cooperation by said Inventor(s) shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor(s) in providing such cooperation shall be paid for by said Assignee.

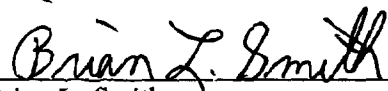
3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor(s), their respective heirs, legal representatives and assigns.

4. Said Inventor(s) hereby jointly and severally warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, said Inventor(s) have executed and delivered this instrument to said Assignee as of the dates written below.

  
\_\_\_\_\_  
Tai Quan

3/19/01  
\_\_\_\_\_  
Date

  
\_\_\_\_\_  
Brian L. Smith

3/19/01  
\_\_\_\_\_  
Date

  
\_\_\_\_\_  
James C. Lewis

3-19-01  
\_\_\_\_\_  
Date